

MOSFET

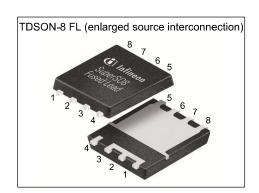
$\mathbf{OptiMOS^{TM}\ Power\text{-}MOSFET,\ 30\ V}$

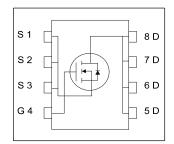
Features

- Optimized for high performance Buck converter
- 175 °C rated
- Very low on-resistance $R_{\rm DS(on)}$ @ $V_{\rm GS}$ =4.5 V
- 100% avalanche tested
- Superior thermal resistance
- N-channel
- Qualified according to JEDEC¹⁾ for target applications
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

Table 1 **Key Performance Parameters**

| Parameter | Value | Unit |
|-------------------------|-------|------|
| V _{DS} | 30 | V |
| R _{DS(on),max} | 1.1 | mΩ |
| I _D | 240 | Α |
| Qoss | 40 | nC |
| Q _G (0V10V) | 72 | nC |











| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|---------------|----------|---------------|
| BSC011N03LST | PG-TDSON-8 FL | 011N03LT | - |

OptiMOSTM Power-MOSFET, 30 V BSC011N03LST



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OptiMOS™ Power-MOSFET, 30 V BSC011N03LST



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

| Danamatan | Constant | | Values | | | |
|---|-----------------------------------|------------------|------------------|--------------------------------|------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Continuous drain current ¹⁾ | I _D | - - - - | - - - - | 240 170 213 150 39 | A | $V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 K/W ²⁾ |
| Pulsed drain current ³⁾ | I _{D,pulse} | - | - | 960 | Α | <i>T</i> _C =25 °C |
| Avalanche current, single pulse ⁴⁾ | I _{AS} | - | - | 50 | Α | <i>T</i> _C =25 °C |
| Avalanche energy, single pulse | EAS | - | - | 190 | mJ | $I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω |
| Gate source voltage ⁵⁾ | V _{GS} | -20 | - | 20 | V | - |
| Power dissipation | P_{tot} | - | - | 115 3.0 | W | T _C =25 °C T _A =25 °C, R _{thJA} =50 K/W ²⁾ |
| Operating and storage temperature | T _j , T _{stg} | -55 | - | 175 | °C | - |

2 Thermal characteristics

Table 3 **Thermal characteristics**

| Parameter | Symbol | Values | | Unit | Note / Test Condition | |
|--|------------|--------|------|------|-----------------------|-----------------------|
| raiailletei | Syllibol | Min. | Тур. | Max. | Ullit | Note / Test Condition |
| Thermal resistance, junction - case, bottom | R_{thJC} | - | _ | 1.3 | K/W | - |
| Thermal resistance, junction - case, top | R_{thJC} | - | _ | 20 | K/W | - |
| Device on PCB, 6 cm ² cooling area ²⁾ | R_{thJA} | - | _ | 50 | K/W | - |

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25°C. For higher case temperature please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information
5) The negative rating is for low duty cycle pulse occurrence. No continuous rating is implied

OptiMOS[™] Power-MOSFET, 30 V BSC011N03LST



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

| | 0 | | Values | | | |
|----------------------------------|----------------------|------|------------|------------|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Drain-source breakdown voltage | V _{(BR)DSS} | 30 | - | - | V | V _{GS} =0 V, I _D =1 mA |
| Gate threshold voltage | $V_{\rm GS(th)}$ | 1.2 | - | 2 | V | $V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =250 μ A |
| Zero gate voltage drain current | I _{DSS} | - | 0.1 10 | 1 100 | μA | V _{DS} =30 V, V _{GS} =0 V, T _j =25 °C V _{DS} =30 V, V _{GS} =0 V, T _j =125 °C |
| Gate-source leakage current | I _{GSS} | - | 10 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V |
| Drain-source on-state resistance | R _{DS(on)} | - | 1.1 0.9 | 1.4 1.1 | mΩ | V _{GS} =4.5 V, I _D =30 A V _{GS} =10 V, I _D =30 A |
| Gate resistance ¹⁾ | R _G | 0.3 | 0.6 | 1.2 | Ω | - |
| Transconductance | g_{fs} | 85 | 170 | - | S | V _{DS} >2 I _D R _{DS(on)max} , I _D =30 A |

 Table 5
 Dynamic characteristics

| Parameter | Cumb al | | Values | | | Note / Test Condition |
|----------------------------------|------------------|------|--------|------|------|--|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Input capacitance ¹⁾ | C _{iss} | - | 4700 | 6300 | pF | V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz |
| Output capacitance ¹⁾ | Coss | - | 1500 | 2000 | pF | V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz |
| Reverse transfer capacitance | C _{rss} | - | 220 | - | pF | V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz |
| Turn-on delay time | $t_{\sf d(on)}$ | - | 6.7 | - | ns | $V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω |
| Rise time | t _r | - | 8.8 | - | ns | $V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω |
| Turn-off delay time | $t_{ m d(off)}$ | - | 37 | - | ns | $V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω |
| Fall time | t _f | - | 6.2 | - | ns | $V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω |

Gate charge characteristics²⁾ Table 6

| Parameter | Cumbal | Values | | | I I m i 4 | Nata / Tank Oardition |
|-------------------------------------|----------------------|--------|------|------|-----------|---|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Gate to source charge ¹⁾ | Q _{gs} | - | 11 | 15 | nC | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate charge at threshold | $Q_{g(th)}$ | - | 7.5 | - | nC | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate to drain charge ¹⁾ | $Q_{ m gd}$ | - | 10.3 | 13 | nC | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Switching charge | Q _{sw} | - | 14 | - | nC | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate charge total ¹⁾ | Q_g | - | 36 | 48 | nC | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate plateau voltage | V _{plateau} | - | 2.4 | - | V | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate charge total ¹⁾ | Q_g | - | 72 | 96 | nC | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 10 V |
| Gate charge total, sync. FET | Q _{g(sync)} | - | 29 | - | nC | V _{DS} =0.1 V, V _{GS} =0 to 4.5 V |
| Output charge ¹⁾ | Qoss | - | 40 | 53 | nC | V _{DD} =15 V, V _{GS} =0 V |

Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition

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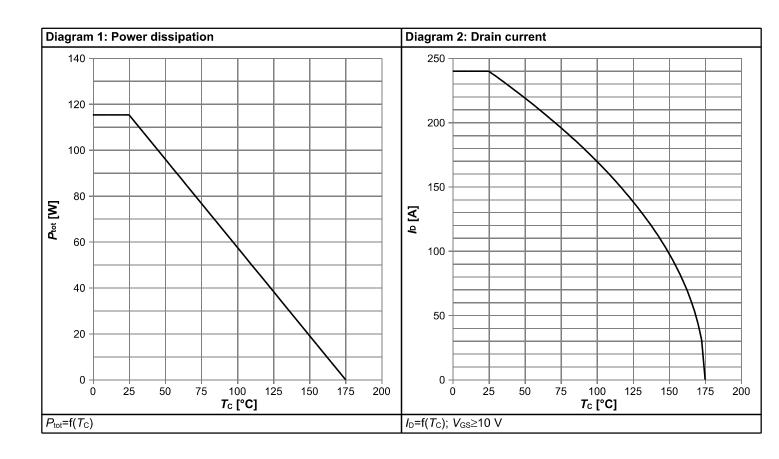


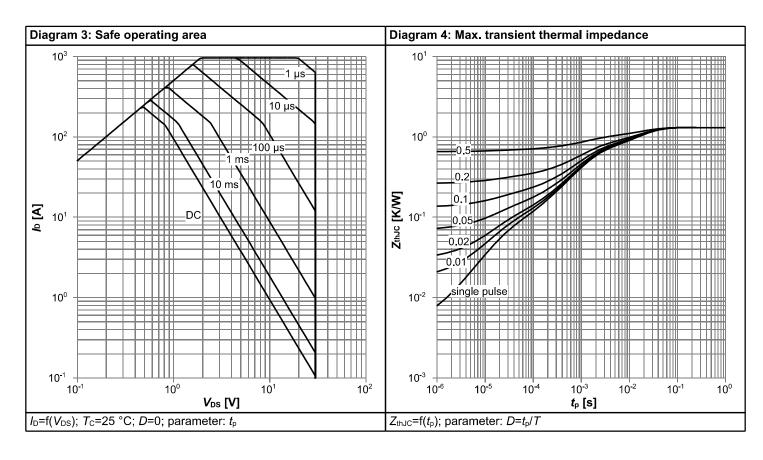
Table 7 Reverse diode

| Dovomotov | Symbol | Values | | | 11 | Nata / Tant Condition |
|----------------------------------|----------------------|--------|------|------|------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Diode continuous forward current | Is | - | | 115 | Α | T _C =25 °C |
| Diode pulse current | I _{S,pulse} | - | - | 960 | Α | T _C =25 °C |
| Diode forward voltage | V _{SD} | - | 8.0 | 1 | V | V _{GS} =0 V, I _F =30 A, T _j =25 °C |
| Reverse recovery charge | Q _{rr} | - | 20 | - | nC | V _R =15 V, I _F =I _S , d <i>i</i> _F /d <i>t</i> =400 A/μs |

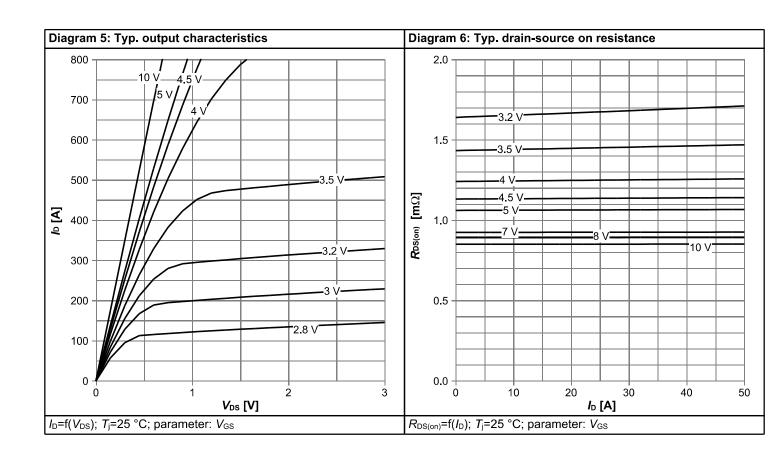


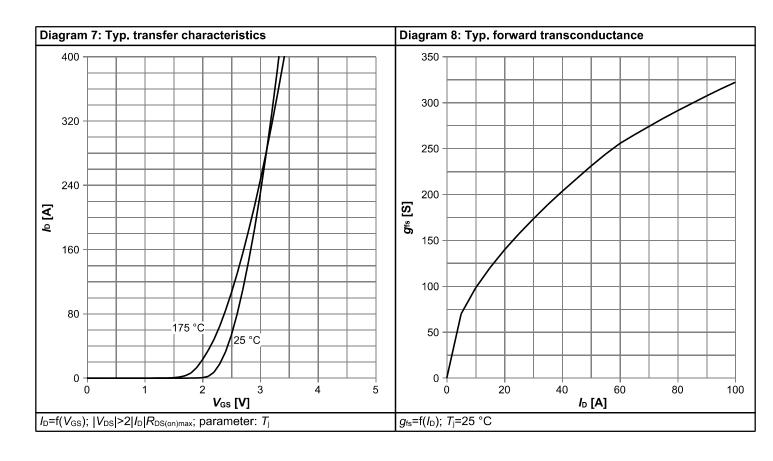
4 Electrical characteristics diagrams



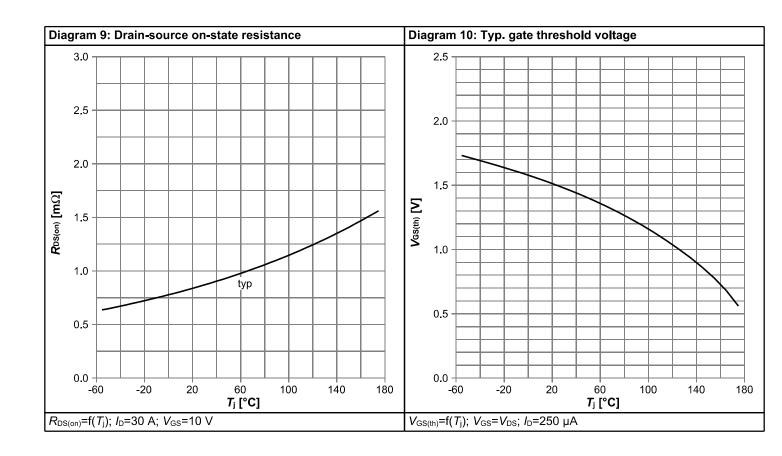


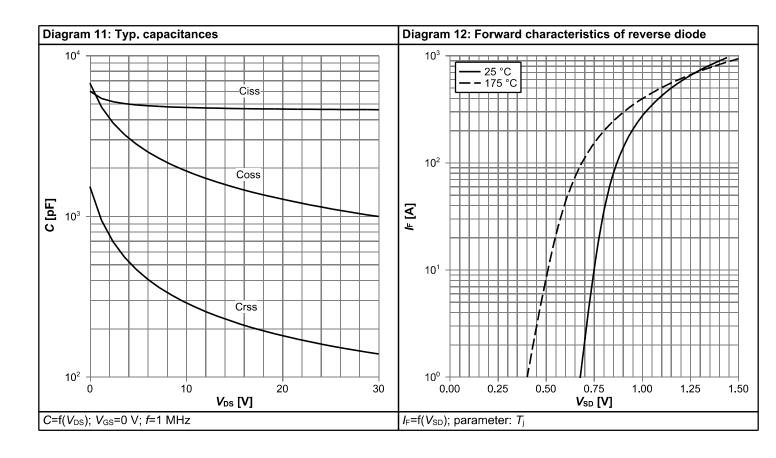




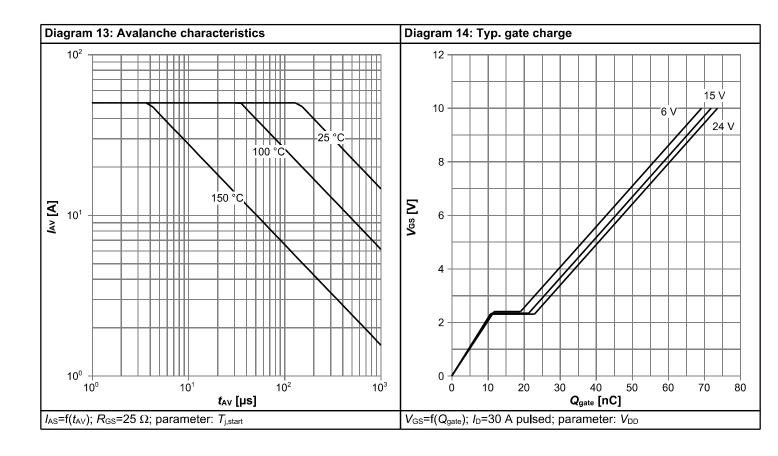


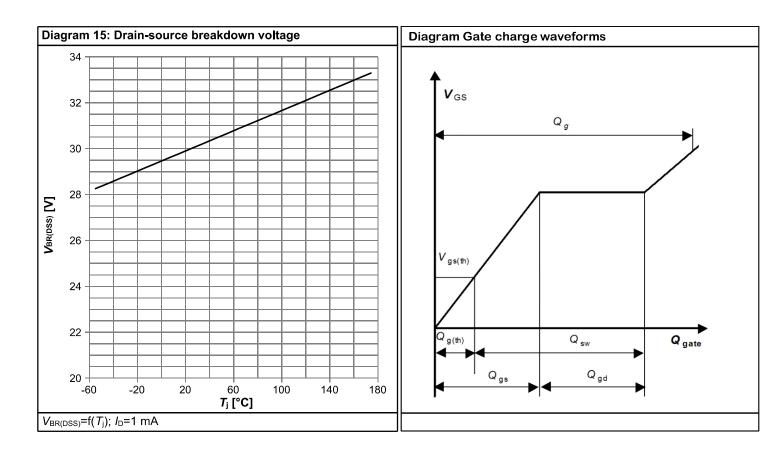






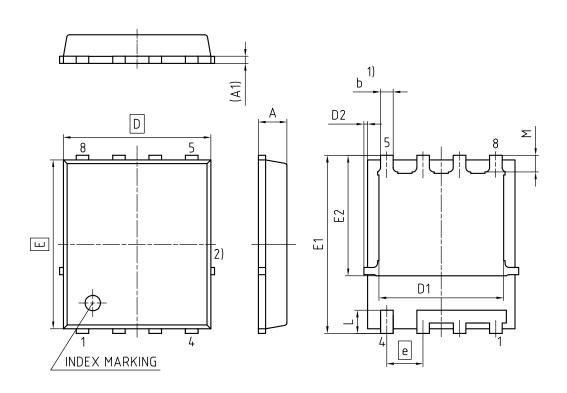








5 Package Outlines



1) EXCLUDING MOLD FLASH
2) REMOVAL ON MOLD GATE
INTRUSION 0.1 MM
PROTRUSION 0.1 MM
LEAD LENGTH UP TO ANTI FLASH LINE
ALL METAL SURFACES ARE PLATED, EXCEPT AREA OF CUT

| DIMENSION | MILLIN | IETERS | | | | |
|-----------|-----------|--------|--|--|--|--|
| DIMENSION | MIN. | MAX. | | | | |
| Α | 0.90 | 1.20 | | | | |
| A1 | 0.15 | 0.35 | | | | |
| b | 0.26 | 0.54 | | | | |
| D | 4.80 | 5.35 | | | | |
| D1 | 3.70 | 4.40 | | | | |
| D2 | 0.02 | 0.23 | | | | |
| E | 5.70 | 6.10 | | | | |
| E1 | 5.90 | 6.42 | | | | |
| E2 | 3.88 | 4.42 | | | | |
| е | 1.27 | | | | | |
| L | 0.69 0.90 | | | | | |
| М | 0.45 | 0.69 | | | | |

| DOCUMENT NO. Z8B000193699 | | | | | |
|------------------------------|-----|--|--|--|--|
| REVISION 03 | | | | | |
| SCALE 10:1 | | | | | |
| 0 1 2 L I I | 3mm | | | | |
| EUROPEAN PROJECTION | | | | | |
| |) | | | | |
| ISSUE DATE 19.06.2019 | | | | | |

Figure 1 Outline PG-TDSON-8 FL, dimensions in mm



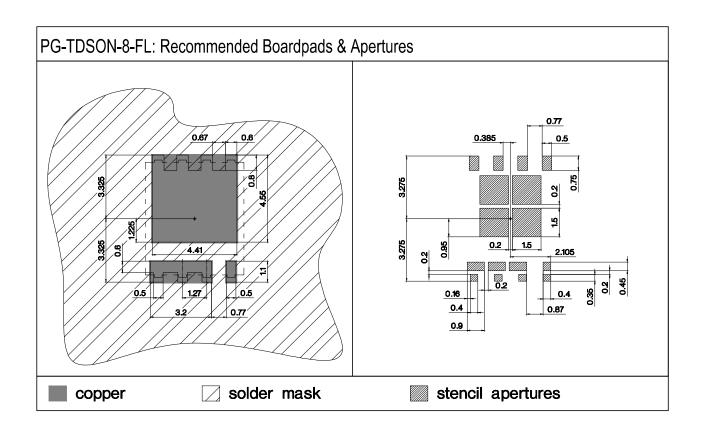


Figure 2 Outline Boardpads (TDSON-8 FL)



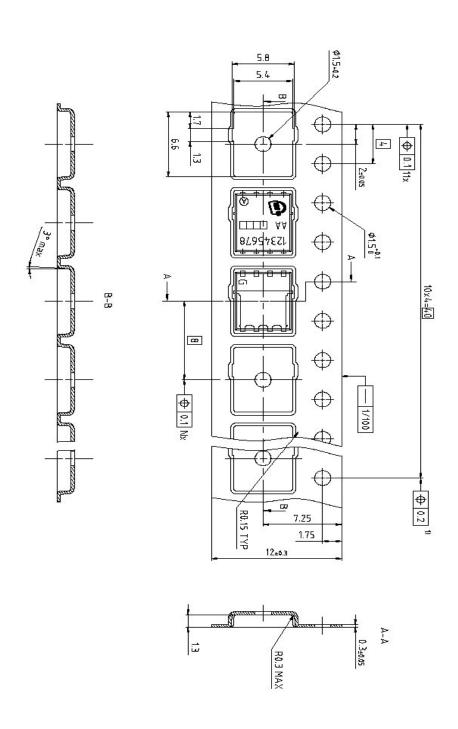


Figure 3 Outline Tape (TDSON-8 FL)

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Revision History

BSC011N03LST

Revision: 2020-11-12, Rev. 2.3

Previous Revision

| Revision | Date | Subjects (major changes since last revision) |
|----------|------------|--|
| 2.0 | 2017-03-01 | Release of final version |
| 2.1 | 2017-10-30 | Insert footnote under Vgs |
| 2.2 | 2019-10-01 | Update package drawings |
| 2.3 | 2020-11-12 | Update current rating |

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